

Irish Standard I.S. EN IEC 60747-17:2020

Semiconductor devices - Part 17: Magnetic and capacitive coupler for basic and reinforced insulation

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I.S. EN IEC 60747-17:2020

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I.S. EN IEC 60747-17:2020 is the adopted Irish version of the European Document EN IEC 60747-17:2020, Semiconductor devices - Part 17: Magnetic and capacitive coupler for basic and reinforced insulation

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EN IEC 60747-17

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EUROPÄISCHE NORM

November 2020

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English Version

Semiconductor devices - Part 17: Magnetic and capacitive coupler for basic and reinforced insulation (IEC 60747-17:2020)

Dispositifs à semiconducteurs - Partie 17: Coupleur magnétique et capacitif pour l'isolation principale et renforcée (IEC 60747-17:2020) Halbleiterbauelemente - Teil 17: Magnetische und kapazitive Koppler für Basisisolierung und verstärkte Isolierung (IEC 60747-17:2020)

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CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 60747-17:2020 (E)

European foreword

The text of document 47E/711/FDIS, future edition 1 of IEC 60747-17, prepared by SC 47E "Discrete semiconductor devices" of IEC/TC 47 "Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60747-17:2020.

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IEC 60060-1:2010	NOTE	Harmonized as EN 60060-1:2010 (not modified)
IEC 60068-1:2013	NOTE	Harmonized as EN 60068-1:2014 (not modified)
IEC 60068-2-6:2007	NOTE	Harmonized as EN 60068-2-6:2008 (not modified)
IEC 60068-2-17:1994	NOTE	Harmonized as EN 60068-2-17:1994 (not modified)
IEC 60068-2-27:2008	NOTE	Harmonized as EN 60068-2-27:2009 (not modified)
IEC 60270:2000	NOTE	Harmonized as EN 60270:2001 (not modified)
IEC 60664-4:2005	NOTE	Harmonized as EN 60664-4:2006 (not modified)
IEC 60747-5-5:2007	NOTE	Harmonized as EN 60747-5-5:2011 (not modified)
IEC 61000-4-5:2014	NOTE	Harmonized as EN 61000-4-5:2014 (not modified)
IEC 61000-4-8:2009	NOTE	Harmonized as EN 61000-4-8:2010 (not modified)
IEC 61000-4-9:2016	NOTE	Harmonized as EN 61000-4-9:2016 (not modified)
IEC 61649:2008	NOTE	Harmonized as EN 61649:2008 (not modified)
IEC 62368-1:2018	NOTE	Harmonized as EN IEC 62368-1:2020 (not modified)

Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60068-2-1	2007	Environmental testing - Part 2-1: Tests - Test A: Cold	EN 60068-2-1	2007
IEC 60068-2-2	2007	Environmental testing - Part 2-2: Tests - Test B: Dry heat	EN 60068-2-2	2007
IEC 60068-2-14	2009	Environmental testing - Part 2-14: Tests - Test N: Change of temperature	EN 60068-2-14	2009
IEC 60068-2-20	2008	Environmental testing - Part 2-20: Tests - Test T: Test methods for solderability and resistance to soldering heat of devices with leads	EN 60068-2-20	2008
IEC 60068-2-30	2005	Environmental testing - Part 2-30: Tests - Test Db: Damp heat, cyclic (12 h + 12 h cycle)	EN 60068-2-30	2005
IEC 60068-2-58	2015	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	2015
IEC 60068-2-67	1995	Environmental testing - Part 2-67: Tests - Test Cy: Damp heat, steady state, accelerated test primarily intended for components	EN 60068-2-67	1996
IEC 60112	2003	Method for the determination of the proof and the comparative tracking indices of solid insulating materials	EN 60112	2003
IEC 60216-1	2013	Electrical insulating materials - Thermal endurance properties - Part 1: Ageing procedures and evaluation of test results	EN 60216-1	2013

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EN IEC 60747-17:2020 (E)

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60216-2	2005	Electrical insulating materials - Thermal endurance properties - Part 2: Determination of thermal endurance properties of electrical insulating materials - Choice of test criteria	EN 60216-2	2005
IEC 60664-1	2007	Insulation coordination for equipment within low-voltage systems - Part 1: Principles, requirements and tests	EN 60664-1	2007
IEC 60672-2	1999	Ceramic and glass insulating materials - Part 2: Methods of test	EN 60672-2	2000
IEC 60695-11-5	2016	Fire hazard testing - Part 11-5: Test flames - Needle-flame test method - Apparatus, confirmatory test arrangement and guidance	EN 60695-11-5	2017
IEC 62539	2007	Guide for the statistical analysis of electrical insulation breakdown data	-	-



IEC 60747-17

Edition 1.0 2020-09

INTERNATIONAL STANDARD

Semiconductor devices -

Part 17: Magnetic and capacitive coupler for basic and reinforced insulation





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IEC 60747-17

Edition 1.0 2020-09

INTERNATIONAL STANDARD

Semiconductor devices -

Part 17: Magnetic and capacitive coupler for basic and reinforced insulation

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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CONTENTS

FC	OREWO	RD	5
1	Scop	e	7
2	Norm	native references	7
3	Term	is and definitions	8
4	Elect	rical characteristics – Coupler logic and timing definitions	19
5		oler for protection against electrical shock	
	5.1	General	
	5.2	Туре	
	5.3	Ratings	20
	5.3.1	General	20
	5.3.2	Safety limiting values	20
	5.3.3	Functional ratings	20
	5.3.4	Rated isolation voltages	20
	5.4	Electrical safety requirements	20
	5.5	Electrical, environmental and/or endurance test information	
	5.5.1	General	21
	5.5.2		
	5.5.3	•	
	5.5.4	5	
	5.5.5	,, , , , , , , , , , , , , , , , , , ,	
6	Meas	suring methods for couplers	35
	6.1	General	
	6.2	Isolation capacitance (C_{IO})	35
	6.2.1	Purpose	35
	6.2.2	Circuit diagram	35
	6.2.3	Measurement procedure	36
	6.2.4	Precautions to be observed	36
	6.2.5	Special conditions	36
	6.3	Isolation resistance between input and output, R _{IO}	36
	6.3.1	Purpose	36
	6.3.2	Circuit diagram	36
	6.3.3	Precautions to be observed	37
	6.3.4	Measurement procedure	37
	6.3.5	Special conditions	37
	6.4	Isolation test	
	6.4.1	•	
	6.4.2	3	
	6.4.3	•	
	6.4.4	•	
	6.5	Partial discharges of coupler	
	6.5.1	•	
	6.5.2	3	
	6.5.3	1	
	6.5.4	•	
	6.5.5	Description of calibration circuit (see Figure 10)	40

6.5.6	lest methods	41
6.5.7	Specified conditions	41
6.5.8	Test voltage conditions	42
6.6	Switching times of couplers	42
6.6.1	Purpose	
6.6.2	Circuit diagram	
6.6.3	Measurement procedure	
6.6.4	Specified conditions	44
	Measuring methods of common-mode transient immunity (CMTI) for nagnetic and capacitive couplers	44
6.7.1	Purpose	
6.7.2	Circuit diagram	
6.7.3	Precautions to be observed	45
6.7.4	Static CMTI measuring procedure	46
6.7.5	Specified conditions	47
6.7.6	Dynamic CMTI measuring procedure	47
Annex A (ir	nformative) Qualification guidance	48
Bibliograph	y	51
Figure 1 –	Time intervals for methods a and b of the test voltage	15
	,2/50 μs surge pulse according 61000-4-5:2014 allowed as equivalent isolation testing	24
•	Determination of time to failure (referring to method in 5.5.5.8)	
Figure 4 –	Determination of working voltage (referring to method in 5.5.5.8 for	
	l model)	32
	Determination of working voltage (referring to method in 5.5.5.8 for non-	33
	, Isolation capacitance measurement circuit	
· ·	' Isolation resistance measurement circuit	
_	Isolation voltage measurement circuit	
J		
	9	
•	- Connections for the calibration of the complete test arrangement	
	- Switching time test circuit	
	- Transition time waveform measurement	
Figure 13 -	- Propagation delay time waveform measurement	44
Figure 14 -	- Static versus dynamic data source signal VI	45
	- Common-mode transient immunity (CMTI) test setup for both static and sting	45
Figure 16 -	- Static common-mode transient immunity (CMTI) and $V_{\hbox{ m CM}}$ and low to high	
	ion waveform	
Figure A.1	– Lifetime verification	49
Table 1 – C	Overview on characteristics and symbols	19
Table 2 – D	Patasheet characteristics	21
	ests and test sequence for coupler providing basic insulation and reinforced or protection against electrical shock	22
	est conditions	
I UDIO T	VOL VOITMINIOTIO	

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	-4-	IEC 60747-17:2020 © IEC 2020
Table 5 – Safety factor F		41
Table 6 – Specified conditions for method	d a and metho	d b42
Table A.1 – Front end process changes v	within compon	ent49

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- 5 -

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SEMICONDUCTOR DEVICES -

Part 17: Magnetic and capacitive coupler for basic and reinforced insulation

FOREWORD

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International Standard IEC 60747-17 has been prepared by subcommittee SC 47E: Discrete semiconductor devices, of IEC technical committee TC 47: Semiconductor devices.

This first edition cancels and replaces IEC PAS 60747-17:2011. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC PAS 60747-17:2011:

- a) introduced lifetime safety factors for improved life time consideration, to comply with widely recognized aging mechanisms of silicone dioxide (TDDB) and thin film polymer isolation layers;
- b) significantly improved "end of life testing" paragraph and statistical life time consideration by adding detailed description on process, safety factors, methods of generating data points and respective lifetime interpolations as well as being specific on minimum amount of samples required;

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- c) introduced concept of certification by similarity, including Annex A, giving guidance on qualification considerations and required certification process;
- d) alternative pulse shape allowed for surge pulse testing, to avoid issues due to surge tester availability;
- e) various improvements throughout the standard: definitions, for example type of coupler have been improved, introduction of surge impulse $V_{\rm IMP}$ rating, usage of glass transition temperature, pre-conditioning have been redefined for improved usability and better compatibility with today's design and functionality of couplers, available mold compounds, etc.

The text of this International Standard is based on the following documents:

FDIS	Report on voting	
47E/711/FDIS	47E/715/RVD	

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60747 series, published under the general title *Semiconductor devices*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

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- · withdrawn,
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- 6 -

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-7-

SEMICONDUCTOR DEVICES -

Part 17: Magnetic and capacitive coupler for basic and reinforced insulation

1 Scope

This part of IEC 60747 specifies the terminology, essential ratings, characteristics, safety test and the measuring methods of magnetic coupler and capacitive coupler.

It specifies the principles and requirements of insulation and isolation characteristics for magnetic and capacitive couplers for basic insulation and reinforced insulation.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

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IEC 60068-2-2:2007, Environmental testing - Part 2-2: Tests - Test B: Dry heat

IEC 60068-2-14:2009, Environmental testing – Part 2-14: Tests – Test N: Change of temperature

IEC 60068-2-20:2008, Environmental testing – Part 2-20: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads

IEC 60068-2-30:2005, Environmental testing – Part 2-30: Tests – Test Db: Damp heat, cyclic (12 h + 12 h cycle)

IEC 60068-2-58:2015, Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)

IEC 60068-2-67:1995, Environmental testing – Part 2: Tests – Test Cy: Damp heat, steady state, accelerated test primarily intended for components

IEC 60112:2003, Method for the determination of the proof and the comparative tracking indices of solid insulating materials

IEC 60216-1:2013, Electrical insulating materials – Thermal endurance properties – Part 1: Ageing procedures and evaluation of test results

IEC 60216-2:2005, Electrical insulating materials – Thermal endurance properties – Part 2: Determination of thermal endurance properties of electrical insulating materials – Choice of test criteria

IEC 60664-1:2007, Insulation coordination for equipment within low-voltage systems – Part 1: Principles, requirements and tests



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